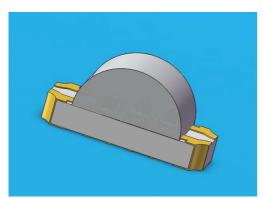


# **DATASHEET**

# SMD ■ B 12-23E/R6GHBHW-C02/2C



### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)..

### **Descriptions**

- The 12-23E SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

### **Applications**

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- · General use.



# **Device Selection Guide**

Code	Chip Materials	Emitted Color	Resin Color
R6	AlGalnP	Brilliant Red	
GH	InGaN	Brilliant Green	White Diffused
ВН	InGaN	Blue	_

# Absolute Maximum Ratings (Ta=25°C)

Absolute Maximum Ratings (1a=25 ()					
Parameter	Symbol	Code	Rating	Unit	
Reverse Voltage	VR		5	V	
Forward Current	lF		20	mA	
		R6	60		
Peak Forward Current (Duty 1/10 @1KHz)	IFP	GH	100	mA	
(Buty 1/10 @ 11(12)		ВН	100		
	Pd	R6	60		
Power Dissipation		GH	75	mW	
		ВН	75	_	
		R6	2000		
Electrostatic Discharge(HBM)	ESD	GH	1000	V	
		ВН	1000	_	
Operating Temperature	T <sub>opr</sub>		-40 ~ +85	°C	
Storage Temperature	Tstg		-40 ~ +90	°C	
Soldering Temperature	Tsol		Reflow Soldering : 260		
			Hand Soldering : 350	C IOI 3 Sec.	



# Electro-Optical Characteristics (Ta=25°℃)

Parameter	Symbol	Code	Min.	Тур.	Max.	Unit	Condition
		R6	72		180		
Luminous Intensity	lv	GH	180		450	mcd	
		ВН	28.5		72		_
Viewing Angle	2θ <sub>1/2</sub>			130		Deg	_
		R6		626		_	
Peak Wavelength	λр	GH		518		nm	
		ВН		468			_
		R6	617.5		629.5		
Dominant Wavelength	λd	GH	520		535	nm	I⊧=5mA
		ВН	465	111	475		
		R6		20			
Spectrum Radiation Bandwidth	$\triangle \lambda$	GH		35		nm	
	_	ВН		25			_
		R6	1.6		2.3	_	
Forward Voltage	$V_{F}$	GH	2.4		3.0	V	
		ВН	2.5		3.1	-	
Reverse Current		R6			10	_	
	$I_{R}$	GH			50	μA	V <sub>R</sub> =5V
		ВН			50		

#### Note:

<sup>1.</sup> Tolerance of Luminous Intensity: ±11%

<sup>2.</sup> Tolerance of Dominant Wavelength: ±1nm

<sup>3.</sup> Tolerance of Forward Voltage: ±0.1V

<sup>4.</sup> RA Test @5mA.



## R6

**Bin Range of Luminous Intensity** 

Bin Code	Min.	Max.	Unit	Condition
Q	72	112	1	L 5 A
R	112	180	mcd	I <sub>F</sub> =5mA

## GH

**Bin Range of Luminous Intensity** 

Bin Code	Min.	Max.	Unit	Condition
S	180	285	1	1 A
Т	285	450	— mcd	I <sub>F</sub> =5mA

**Bin Range of Dominant Wavelength** 

Bin Code	Min.	Max.	Unit	Condition
X	520	525		_
Υ	525	530	nm	I <sub>F</sub> =5mA
Z	530	535		

# BH

**Bin Range of Luminous Intensity** 

Bin Code	Min.	Max.	Unit	Condition
N	28.5	45		1 5 · A
Р	45	72	— mcd	I <sub>F</sub> =5mA

**Bin Range of Dominant Wavelength** 

Bin Code	Min.	Max.	Unit	Condition
X	465	470		L 5 A
Υ	470	475	mm nm	I <sub>F</sub> =5mA

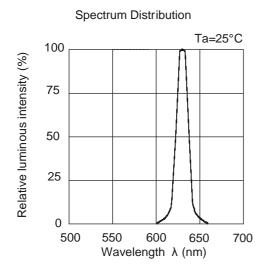
### Note:

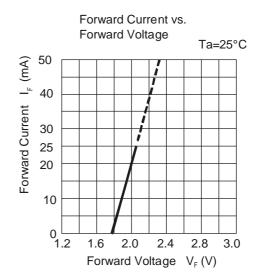
1. Tolerance of Luminous Intensity: ±11%

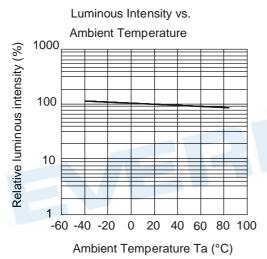
2. Tolerance of Dominant Wavelength: ±1nm

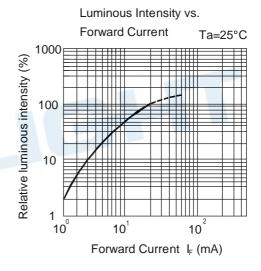


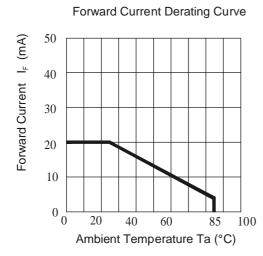
# Typical Electro-Optical Characteristics Curves R6

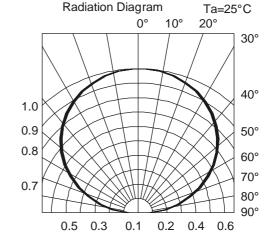






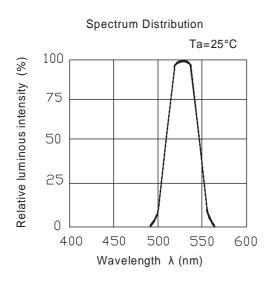


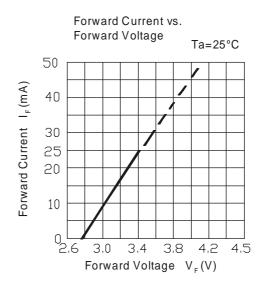


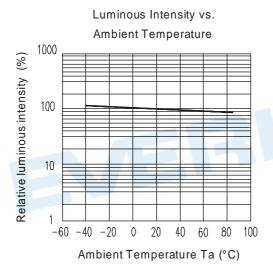


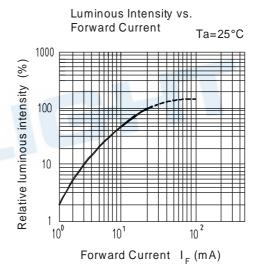


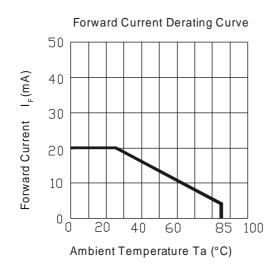
# **Typical Electro-Optical Characteristics Curves** GH

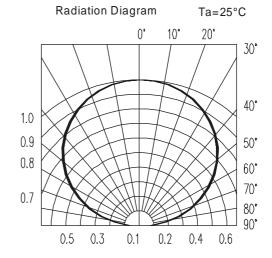






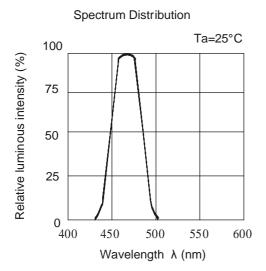


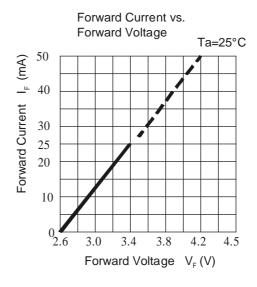


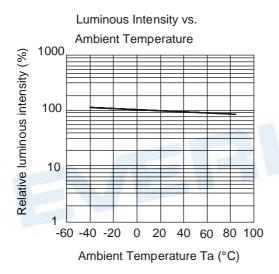


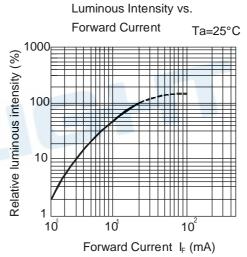


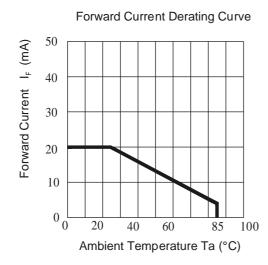
# **Typical Electro-Optical Characteristics Curves**

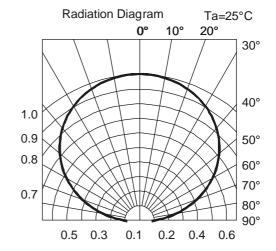




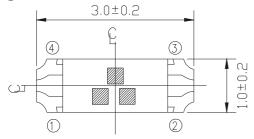


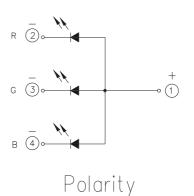


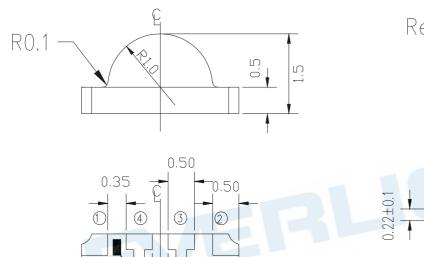




# **Package Dimension**



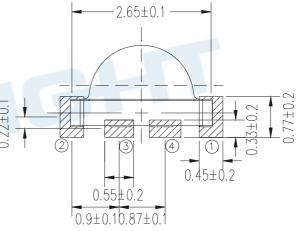




(3)

Anode Mark

Recommend Soldering Pad



Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

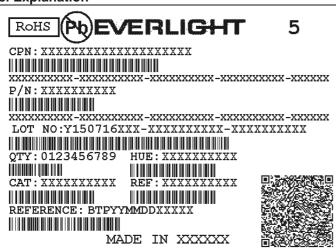
0.30

4



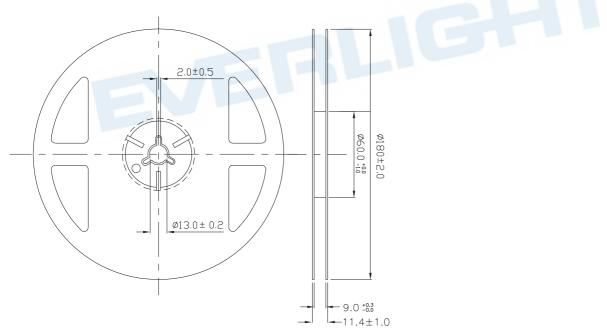
## **Moisture Resistant Packing Materials**

**Label Explanation** 



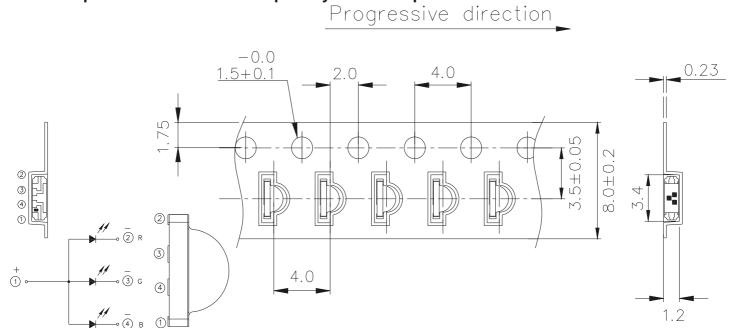
- CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- · CAT: Luminous Intensity Rank
- · HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- REF: Forward Voltage Rank
- · LOT No: Lot Number

## **Reel Dimensions**



Note: The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

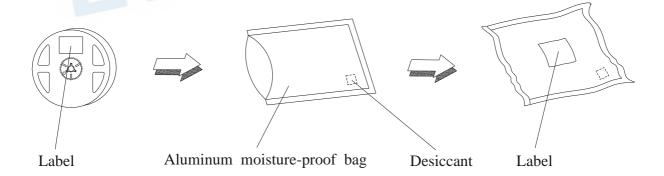
# Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: Tolerances unless mentioned ±0.1mm. Unit = mm

### **Moisture Resistant Packing Process**

Polarity





### **Precautions For Use**

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

### 2. Storage

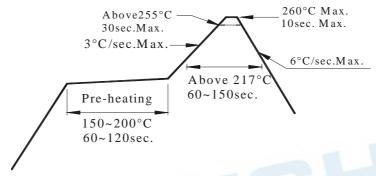
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30℃ or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 168hrs under 30℃ or less and 60% RH or less.

If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment:  $60\pm5^{\circ}$ C for 24 hours.

### 3. Soldering Condition

3.1 Pb-free solder temperature profile



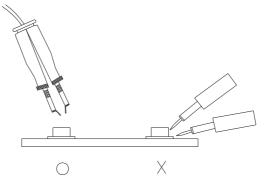
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





## **Application Restrictions**

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

### **DISCLAIMER**

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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